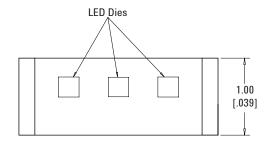
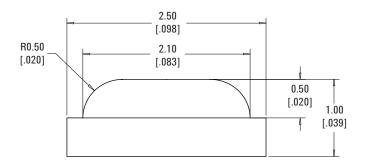
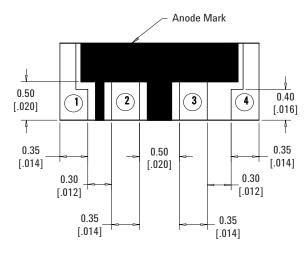
# **Package Dimensions**







### Notes:

- 1. All Dimensions in millimeteres (inches)
- 2. Tolerance is  $\pm 0.1$ mm ( $\pm 0.004$  in) unless otherwise specified

POLARITY		HSMF-C113	HSMF-C115
		InGaN BLUE	InGaN BLUE
20-	3	AlinGaP RED	AllnGaP RED
	4	AlinGaP GREEN	InGaN GREEN

## Absolute Maximum Ratings at $T_A = 25$ °C

Parameter	AlinGaP Red	AllnGaP Green	InGaN Green	InGaN Blue	Units
DC Forward Current <sup>[1,3]</sup>	20	20	20	20	mA
Power Dissipation <sup>[1]</sup>	48	52	78	78	mW
DC Forward Current <sup>[2]</sup>	15	15	15	15	mA
Power Dissipation <sup>[2</sup> ]	36	39	59	59	mW
Reverse Voltage (I <sub>R</sub> = 100mA)	5	5	5	5	V
LED Junction Temperature	95	95	95	95	°C
Operating Temperature Range		-40 to	o +85		°C
Storage Temperature Range		-40 to	o +85		°C
Soldering Temperature		See IR soldering p	rofile (Figure 6 & 7)		

#### Notes:

- 1. Applies when single LED is lit up.
- 2. Applies when all 3 LEDs are lit up simultaneously.
- 3. Derate linearly as shown in Figure 4.
- 4. Drive currents above 5 mA are recommended for best long term performance.

## Electrical Characteristics at $T_A = 25$ °C

	VF (Ve	l Voltage olts) <sup>[1]</sup> : 20mA	Reverse Breakdown V <sub>R</sub> (Volts) @ I <sub>R</sub> = 100mA	Capacitance $C(pF)$ , @ $V_F = 0$ , $f = 1MHz$	Thermal Resistance $R\theta_{ extsf{J-PIN}}$ (°C/W)
Part Number	Тур.	Max.	Min.	Typ.	Typ.
AlinGaP Red	1.9	2.0	5	12	550
AllnGaP Green	2.0	2.6	5	15	300
InGaN Green	3.4	3.9	5	65	400
InGaN Blue	3.4	3.9	5	65	400

Notes:

1.Vf tolerance: ±0.1V

## Optical Characteristics at $T_A = 25$ °C

	l <sub>V</sub> [1	us Intensity ¹ (mcd) 20mA	Peak Wavelength $\lambda_{ extsf{peak}}$ (nm)	Color, Dominant Wavelength $\lambda_{\mathbf{d}}^{[2]}$ (nm)	Viewing Angle $2\theta_{1/2}^{[3]}$ (Degrees)	Luminous Ef- ficacy ην (lm/W)
Part Number	Min.	Тур.	Typical	Typical	Typical	Typical
AllnGaP Red	28.5	80.0	637	626	120	155
AllnGaP Green	18.0	50.0	570	572	125	570
InGaN Green	71.5	170.0	523	525	125	443
InGaN Blue	28.5	60.0	468	470	125	89

#### Notes:

- 1. The luminous intensity I<sub>V</sub> is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the LED package.
- 2. The dominant wavelength,  $\lambda_d$ , is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
- 3.  $\theta_{1/2}$  is the off-axis angle where the luminous intensity is  $1\!\!/_2$  the peak intensity.

### **CAUTION:**

- 1. The above optical performance specifications are valid in the case when single LED is lit up.
- 2. The above product specifications DO NOT provide any guarantee on color mixing, color consistency over time, or uniformity in luminous intensity when more than 1 LED is lit.
- Please refer to Avago Technologies Application Brief AB D-007 for additional details / explanation on driving the part in parallel circuit.

## Light Intensity (I<sub>V</sub>) Bin Limits<sup>[1]</sup>

	Intensity (mcd)		
Bin ID	Minimum	Maximum	
A	0.11	0.18	
В	0.18	0.29	
С	0.29	0.45	
D	0.45	0.72	
E	0.72	1.10	
F	1.10	1.80	
G	1.80	2.80	
Н	2.80	4.50	
J	4.50	7.20	
K	7.20	11.20	
L	11.20	18.00	
M	18.00	28.50	
N	28.50	45.00	
P	45.00	71.50	
Q	71.50	112.50	
R	112.50	180.00	
S	180.00	285.00	
Т	285.00	450.00	

Tolerance: ±15%

#### Notes:

 Bin categories are established for classifi-cation of products. Products may not be available in all categories. Please contact your Avago Technologies representative for information on current available bins.

### AllnGaP Red Color Bin Limits[1]

	Dom. Wavelength (nm)	
Bin ID	Minimum	Maximum
	620.0	635.0

 $Tolerance: \pm 1 nm$ 

## AllnGaP Green Color Bin Limits<sup>[1]</sup>

	Dom. Wavelength (nm)	
Bin ID	Minimum	Maximum
A	561.5	564.5
В	564.5	567.5
С	567.5	570.5
D	570.5	573.5
Е	573.5	576.5

Tolerance: ±1nm

### InGaN Green Color Bin Limits[1]

	Dom. Wavelength (nm)		
Bin ID	Minimum	Maximum	
A	515.0	520.0	
В	520.0	525.0	
С	525.0	530.0	
D	530.0	535.0	

 $Tolerance: \pm 1 nm$ 

## InGaN Blue Color Bin Limits[1]

	Dom. Wavelength (nm)		
Bin ID	Minimum	Maximum	
A	460.0	465.0	
В	465.0	470.0	
С	470.0	475.0	
D	475.0	480.0	

Tolerance: ±1nm

#### Notes:

 Bin categories are established for classifi-cation of products. Products may not be available in all categories. Please contact your Avago Technologies representative for information on current available bins.

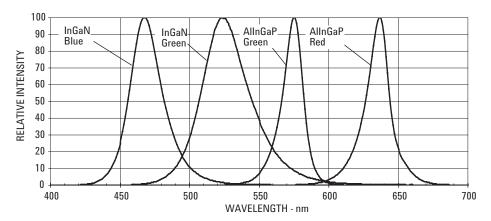


Figure 1. Relative intensity vs. wavelength.

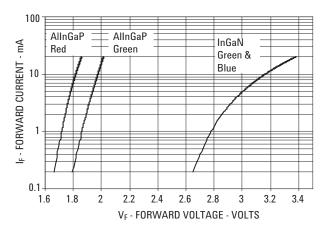


Figure 2. Forward current vs. forward voltage.

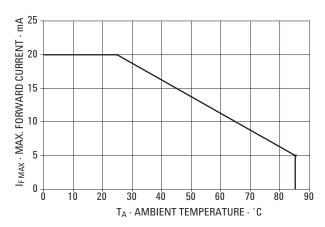


Figure 4. Maximum forward current vs. ambient temperature.

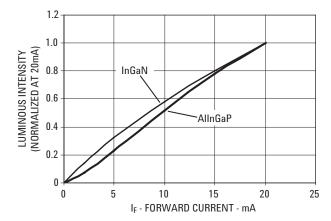


Figure 3. Luminous intensity vs. forward current.

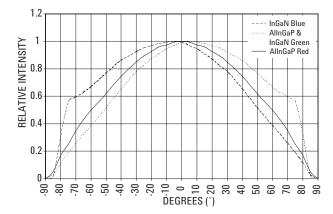


Figure 5. Relative intensity vs. angle.

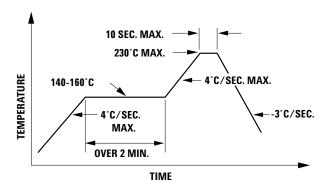


Figure 6. Recommended reflow soldering profile.

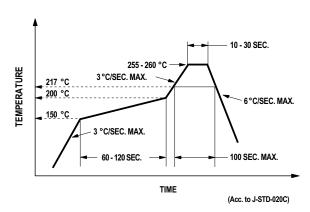


Figure 7. Recommended Pb-free reflow soldering profile.

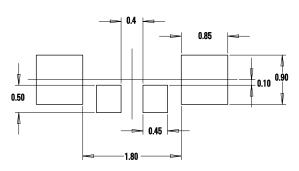
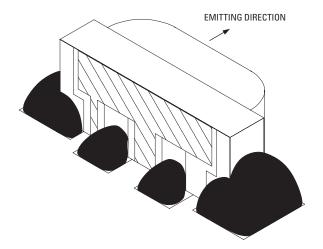


Figure 8. Recommended soldering land pattern.

#### Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 mm$  ( $\pm 0.004 in.$ ) unless otherwise specified.



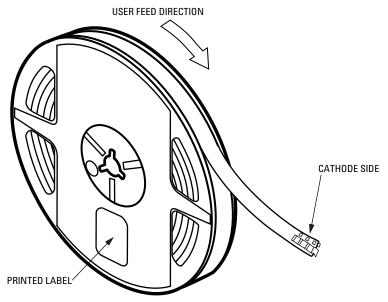


Figure 9. Reeling orientation.

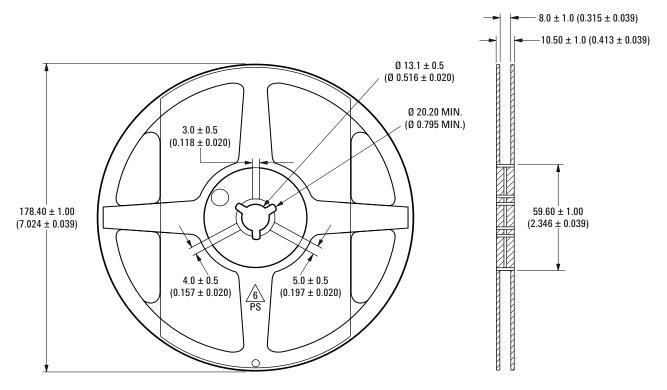
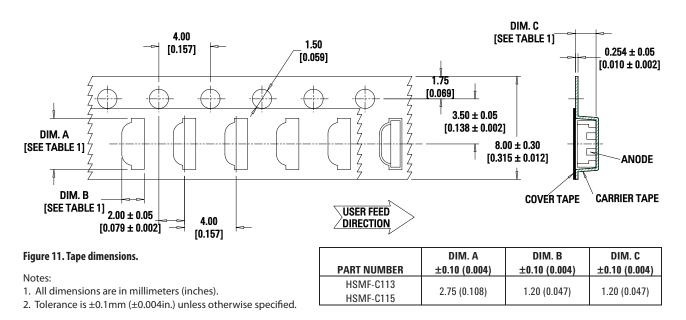


Figure 10. Reel dimensions.



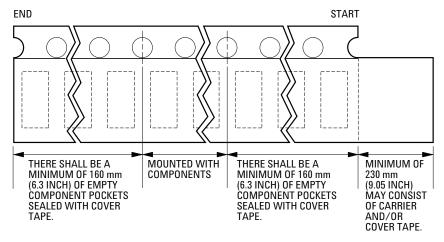


Figure 12. Tape leader and trailer dimensions.

### **Reflow Soldering:**

For more information on reflow soldering, refer to Application Note AN-1060, Surface Mounting SMT LED Indicator Components.

**Storage Condition:** 5 to 30°C @ 60%RH max.

Baking is required before mounting, if:

- 1. Humidity Indicator Card is > 10% when read at 23  $\pm$  5°C.
- 2. Device expose to factory conditions <30°C/60%RH more than 672 hours.

**Recommended baking condition:** 60±5°C for 20 hours.

For product information and a complete list of distributors, please go to our web site:

www.avagotech.com

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